

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: Akira NAKASUGA et al.

Serial No.: Divisional of 08/861,005

Group Art Unit: 1771 (prior)

Filed: January 31, 2002

Examiner: D. Zirker (prior)

For: SHEET-FORM, CURABLE PRESSURE-SENSITIVE ADHESIVE

PRELIMINARY AMENDMENT

Commissioner for Patents
Washington, D.C. 20231

January 31, 2002

Sir:

Prior to calculation of the filing fee and examination of this application, please amend the above-identified application as follows:

CLEAN VERSION OF AMENDMENTS

IN THE CLAIMS

Please cancel claims 1-11 and 13 without prejudice or disclaimer, amend claim 12, and add new claims 14-22 as follows:

12. (Amended) A method for joining members comprising the steps of:
placing the sheet-form, curable pressure-sensitive adhesive on one of said members, said curable pressure sensitive adhesive comprising a composition including:

- (A) a high molecular weight polymer having a pressure-sensitive adhesive property and having a molecular weight of several tens of thousands to 5 million;
- (B) a compound containing an epoxy group; and
- (C) a polymerization initiator which, when an activation energy is applied thereto,

5/A
D.G.
8-5-02

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